



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re the Application of: **MARUTA, Yukio, et al.**

Group Art Unit: **2822**

Serial No.: **10/708,587**

Examiner: **Kevin M. PICARDAT**

Filed: **March 12, 2004**

**P.T.O. Confirmation No.: 2586**

**FOR: METHOD AND DEVICE FOR CUTTING WIRE FORMED ON SEMICONDUCTOR  
SUBSTRATE**

**AMENDMENT UNDER 37 CFR §1.111**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

September 28, 2005

Sir:

In response to the Office Action dated **June 30, 2005**, please amend the above-identified application as follows:

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 8 of this paper.